



Pulp and Paper Industry Committee IEEE James A. Rooks Memorial Grant Fund Young Engineering Professionals Program

One of the challenges the Pulp and Paper Industry faces looking forward is attracting and retaining young electrical engineering professionals to the industry. Recognizing this need, the IEEE Pulp and Paper Industry Committee (PPIC) has arranged with the IEEE Industry Applications Society (IAS) to provide a limited number of partial financial sponsorships for young engineers to attend to the Annual Conference.

This provides a low-cost opportunity for young engineering professionals to experience this forum for the exchange of electrical applications technology relating to forest products-based industry. This is a great way to meet other industry engineers, learn solutions to real mill needs, and network with senior industry professionals.

What is included?

- ✓ Free Conference Registration
- ✓ One Tutorial
- ✓ Conference Reception
- ✓ Vendor Exhibition
- ✓ Meals at the Conference
- ✓ Free first year of IEEE and IAS Membership

What are the requirements?

- Full time employee of a Pulp and Paper Products Industry end-user (Pulp, Paper, Board, Tissue, etc.) or consulting engineer working in support of clients in the industry.
- Less than 5 years of experience in the industry.
- Have never previously attended a IEEE Pulp and Paper Industry Technical Conference.
- The young engineer must attend one PPIC sub-committee meeting and the general committee meeting on Tuesday.
- IEEE/IAS will reimburse either the employee or company for the documented travel costs of airfare, other transportation and meals up to a maximum of \$1,000 per young engineering professional.
- Conference Registration and IEEE Membership will be refunded after conference attendance. If you are unable to attend after registering, normal cancellation policy will be in effect.

A few highlights from the Conference:

- We begin with the Welcome Reception at the hotel on Sunday night.
- Great technical papers presented Monday through Wednesday followed by interesting tutorials on Thursday (and sometimes Friday) will be presented during the Conference.
- Many vendor exhibits will be available to visit throughout the conference.
- The Wednesday Conference Awards Luncheon & Closing Social is a fun event to finish the Conference.
- The PPIC Subcommittee meetings are on Tuesday from 12 noon until 5pm. The subcommittees are where the papers, tutorials, and other topics are generated for upcoming conferences.



We have four subcommittees consisting of:

- DCS Drives and Control Systems
- PCEMC Process Control, Engineering, Maintenance and Construction
- PDS Power Distribution Systems
- S&T Safety and Training

We also have a Standards subcommittee, which is currently developing a Recommended Practice for Specifying AC Coordinated Adjustable Speed Drive Systems for Operation on 3 Phase AC 50/60 Hertz up to 1000 Volts for Pulp and Paper Industry Installations.

Visit www.pulppaper.org for more information on the Conference!

Please fill out the following:

Name	
Title (Electrical Engineer, Reliability Engineer, etc.)	
IEEE Member number, if already a member	
Active email address	
Phone number	
Company	
Company Location (Mailing Address)	
College	
Degree and Graduation Date	
Subcommittee Preference	

If you are not currently a member of IEEE and the IAS, you will be required to sign up for IEEE before attending the conference and will be reimbursed after the conference. IAS application will be completed at the conference.

The final selection of the successful applicants will be based on the qualifications listed above, the order that the applications were received, and how many applicants there are from different companies. Successful applicants will be notified as quickly as possible.

Please return this application by **MAY 10** via e-mail to:

Emily Held
emily.held@ieee.org
217-827-4099